

UPD1001

Programmable USB Power Delivery Controller

Highlights

- Integrated USB Power Delivery (PD) PHY
- Support for Power Delivery Message Protocol
- Integrated Voltage and Current ADC Inputs
- · Configuration Profile Selection
- · On-chip Microcontroller
- · SPI Interface
- Commercial, Industrial, and Automotive Grade Temperature Support
- Available in 28-TSSOP and 32-SQFN Packages

Target Applications

- · AC Adapters & Chargers
 - Type-A
 - Type-B
 - Micro-A
 - Micro-B
 - Captive cable

Key Benefits

- · Integrated USB Power Delivery (PD) PHY
 - Integrated receive termination
 - Requires minimal external components
- Support for Power Delivery Message Protocol
 - Message Generation/Consumption
 - Retry Generation
 - Error Handling
 - State Behavior
- Cable Detect Logic
 - Cable attachment type
- CFG_SEL pins allow selection of multiple profiles
 - Provider
 - Consumer/Provider
- Integrated Voltage (VMON) and Current (IMON) ADC Inputs
- Dead Battery Support
- · On-chip Microcontroller
 - Manages I/Os and other signals
 - Implements power delivery policy engine and device policy manager
- Configuration Programming via OTP, or Vendor Defined Messaging
- Supports Low Power Modes
- Serial Peripheral Interface (SPI) Bus
- Internal 3.3 V and 1.8 V Voltage Regulators
- Integrated Oscillator Reduces BOM Costs
- Package
 - 28-pin TSSOP (9.7 x 6.1 mm)
 - 32-pin SQFN (5 x 5 mm)
- Environmental
 - Commercial temperature range (0°C to +70°C)
 - Industrial temperature range (-40°C to +85°C)
 - Automotive temperature range (-40°C to +105°C)

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1.0 INTRODUCTION

1.1 General Description

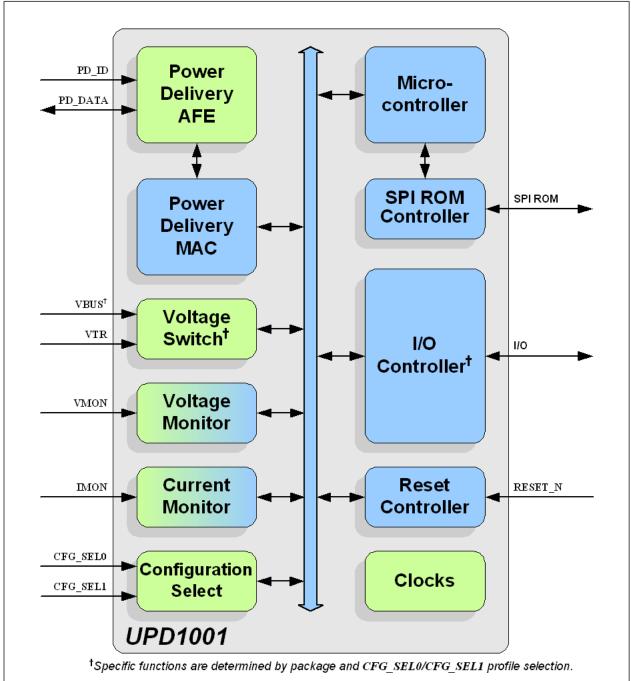
The UPD1001 is a programmable USB Power Delivery (PD) controller designed to adhere to the *USB Power Delivery Specification*. USB Power Delivery allows a host (or device) to provide or consume up to 5 Amps and/or up to 20 Volts of power from a USB PD capable partner device on the other end of the USB cable. USB PD capable standard and custom cables/connectors are supported, which in most cases are backward compatible with standard USB connections.

The UPD1001 provides a complete USB Power Delivery solution for all charger and adapter solutions. The functionality of the UPD1001 is selected via two configuration selection pins, CFG_SEL0 and CFG_SEL1, which can be used to select unique PD and system configurations. Designing the UPD1001 into a system can be as simple as selecting a configuration, with no external EEPROM required. Advanced programmability options exist with an external EEPROM installed.

The integrated USB Power Delivery MAC and PHY support provider and consumer operation via the PD communication protocol, as specified in Revision 1.0 (Version 1.2) of the *USB Power Delivery Specification*. Monitoring of VBUS and battery charging is accomplished via the integrated voltage and current ADC inputs. The PHY supports cable ID detection/identification and loopback modes. The PHY includes a 24MHz FSK modulator/demodulator and provides integrated terminations. The USB PD MAC supports both USB PD insertion detection (cold socket) and dead battery cases.

The on-chip microcontroller manages the IOs and implements the power delivery local policy engine and device manager. The SPI ROM controller is used by the microcontroller for optional external code execution from ROM. A One Time Programmable (OTP) ROM is integrated in the UPD1001. Integrated 3.3 V and 1.8 V regulators allow device operation from a single power supply. The UPD1001 is available in commercial (0°C to +70°C), industrial (-40°C to +85°C), and automotive (-40°C to +105°C) temperature ranges. An internal block diagram of the UPD1001 is shown in Figure 1-1.

FIGURE 1-1: INTERNAL BLOCK DIAGRAM



2.0 PACKAGE OUTLINES

2.1 28-TSSOP

FIGURE 2-1: 28-TSSOP PACKAGE (DRAWING)

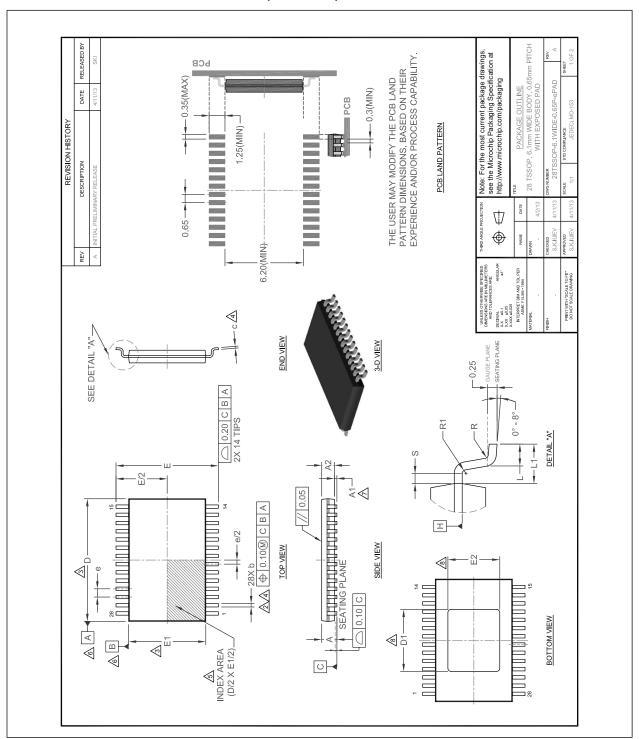


FIGURE 2-2: 28-TSSOP PACKAGE (DIMENSIONS)

	REVISION HISTORY		
REV	DESCRIPTION	DATE	RELEASED BY
<	INITIAL PRELIMINARY RELEASE	4/11/13	SKI

																_
REMARK	OVERALL PACKAGE HEIGHT	STANDOFF	BODY THICKNESS	X BODY SIZE	X EXPOSED PAD	LEAD SPAN	Y BODY SIZE	Y EXPOSED PAD	LEAD FOOT LENGTH	LEAD LENGTH	LEAD WIDTH	LEAD FOOT THICKNESS	LEAD PITCH	LEAD SHOULDER	LEAD FOOT RADIUS	LEAD SHOULDER RADIUS
NOTE	-	2	-	3		1	3		-		2,4	4	-	-	-	
MAX	1.20	0.15	1.05	9.80	5.00		6.20	4.20	0.75		0:30	0.20		ı	ı	
MOM	ı	ı	1.00	9.70	4.90	8.10 BSC	6.10	4.10	09.0	1.00 REF		ı	0.65 BSC	-		
ZΙΣ	ı	00.0	08.0	9.60	4.80		00.9	4.00	0.45		0.19	60.0		0.20	60.0	60.0
SYMBOL	A	A1	A2	٥	10	ш	E1	E2	Γ	L1	q	S	ө	S	W.	R1

NOTES:

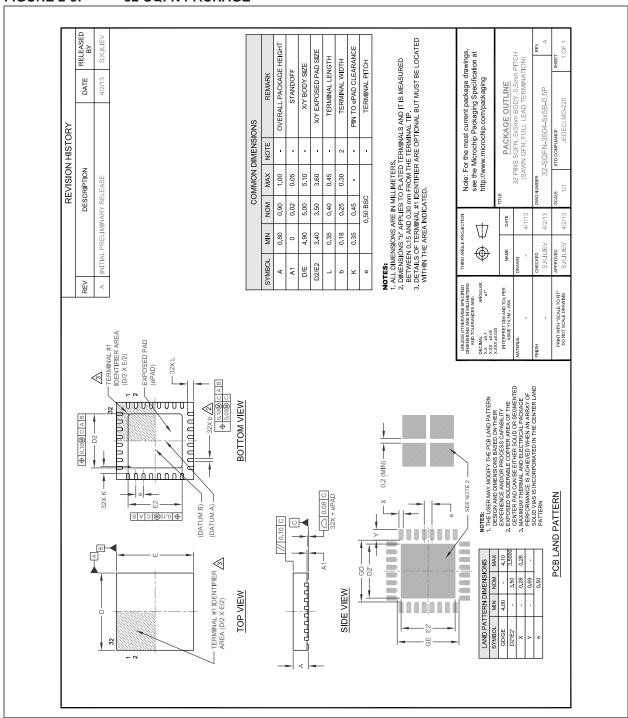
- 1. ALL DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES). 2. DIMENSION "b" DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR
 - 2. DIMENSION "b" DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAME PROTRUSION SHALL BE 0.08 MM TOTAL IN EXCESS OF THE "b" DIMENSION AT MMC. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD IS 0.07 MM.
- 3. DIMENSION OF DOCUMENT TO THE TASK PROTECTION THE TO THE TOTAL OF THE TASK THE BURRS IS 0.15 MM PER SIDE. DIMENSION "E1" DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. MAXIMUM INTERLEAD FLASH OR PROTRUSION IS 0.25 MM PER SIDE. "D" & "E1"
 - DIMENSIONS ARE DETERMINED AT DATUM PLANE "H".
 4. "b" & "c" APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 TO 0.25 MM FROM THE LEAD TIP.
 - 5. DETAILS OF THE PIN 1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
- 6. DATUMS "A" AND "B" TO BE DETERMINED AT DATUM PLANE "H".
 7. "A1" IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY, EXCLUDING ANY THERMAL
 - ENHANCEMENT ON CAVITY DOWN PACKAGE CONFIGURATIONS. 8. "D1" AND "E2" DIMENSIONS DO NOT INCLUDE MOLD FLASH

UNICES OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS AND TOLERANICES ARE: DECIMAL XX 40.1 XXX 40.05	THIRD ANGLE PROJECT	N TT	Note: For see the M http://www	Note: For the most current package drawings, see the Microchip Packaging Specification at http://www.microchip.com/packaging	wings, on at
X.XXX ±0.025			ALAN C.		
INTERPRET DIM AND TOL PER ASME Y14.5M - 1994	NAME	DATE	4	PACKAGE OUTLINE	
MATERIAL	DRAWN		28 TSSO	28 TSSOP, 6.1mm WIDE BODY, 0.65mm PITCH	n PITCH
		4/2/13		WITH EXPOSED PAD	
FINISH	CHECKED		DWG NUMBER		REV
	S.K.ILIEV	4/11/13	28TS	28TSSOP-6.1WIDE-0.65P-ePAD	⋖
PRINT WITH "SCALE TO FIT"	APPROVED		SCALE	STD COMPLIANCE SHE	SHEET
DO NOT SCALE DRAWING	S.K.ILIEV 4/11/13 1:1	4/11/13	1:1	JEDEC: MO-153	2 OF 2

COMMON DIMENSIONS

2.2 32-SQFN

FIGURE 2-3: 32-SQFN PACKAGE



UPD1001

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PART NO Device	[X] - XX / XX T Tape and Reel Temperature Package Option Range	Exa a) b)	Tray, UPD	1001-A/ST Commercial temp., 28-pin TSSOP 1001T-AI/MQ
Device: Tape and Reel Option:	UPD1001 Blank = Standard packaging (tray) T = Tape and Reel ^(Note 1)		таре	& reel, Industrial temp., 32-pin SQFN
Temperature Range: Package:	A = 0°C to +70°C (Commercial) AI = -40°C to +85°C (Industrial) AV = -40°C to +105°C (Automotive) ST = 28-pin TSSOP MQ = 32-pin SQFN	Not	e 1:	Tape and Reel identifier only appears in
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